## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	73	(murakami-keiichi).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2007/12/15 00:34
S2	4	(murakami-keiichi).in. and (printed adj wiring adj board)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2008/02/21 17:59
SS	4	("20050258522"   "20060037193"   "20060115582"   "6739040"). PN.	US-PGPUB; USPAT; USOOR	OR	OFF	2008/02/21 18:09
S4	5	("3956041"   "5057372"   "5344893"   "5346750"   "6376053").PN.	US-PGPUB; USPAT; USOOR	OR	OFF	2008/02/23 22:24
S5	6	("3989767"   "4504607"   "4752499"   "5021472"   "5055321"   "5137936").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/02/23 22:37
S6	57	("5055321").URPN.	USPAT	OR	OFF	2008/02/23 22:45
S7	12	("4752499"   "5021472"   "5055321"   "5344893"   "5447996"   "5519177"   "5589255"   "5688583"   "5741575"   "5795618"   "5921472"   "6010768").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/02/23 23:12
S8	8	("6248428").URPN.	USPAT	OR	OFF	2008/02/23 23:13
S9	202	(pcb or ((circuit or wiring) adj board)) and (press\$3 with resin) and (cur\$3 with resin) and (polish\$3 with resin)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/23 23:17
S10	101	(pcb or ((circuit or wiring) adj board)) and (press\$3 with resin) and (cur\$3 with resin) same (polish\$3 with resin)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/23 23:17
S11	15	(pcb or ((circuit or wiring) adj board)) and (press\$3 with resin) same (cur\$3 with resin) same (polish\$3 with resin)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/23 23:17
S12	14	(pcb or ((circuit or wiring) adj board)) and (press\$3 with resin) and (polish\$3 with resin) and pressing adj plate	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/24 22:42
S15	18	(pcb or ((circuit or wiring) adj board)) and (press\$3 with prepreg) and (pressing adj plate)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/24 22:48

S16	8	("3884771").URPN.	USPAT	OR	OFF	2008/02/24 22:50
S17	1	(pcb or ((circuit or wiring) adj board)) and (press\$3 with heat \$3) and (pressing adj plate) near4 nickel	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/24 22:52
S21	504	(pcb or ((circuit or wiring) adj board)) and (press\$3 with heat \$3 with prepreg) with (laminat \$3)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/24 22:54
S22	197	(pcb or ((drcuit or wiring) adj board)) and (press\$3 with heat \$3 with prepreg) with (laminat \$3) and nickel	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/24 22:55
S23	18	(pcb or ((circuit or wiring) adj board)) and (press\$3 with heat \$3 with nickel) with (laminat\$3)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/24 23:03
S24	105	(pcb or ((circuit or wiring) adj board)) and (press\$3 with heat \$3 with nickel)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/24 23:03
S25	6	("4541894"   "5450290"   "5484647"   "5525402"   "5600103"   "5766670").PN.	US-PGPUB; USPAT; USOOR	OR	OFF	2008/02/24 23:10
S26	45	(pcb or ((circuit or wiring) adj board)) and ((press\$3 with heat \$3) same (nickel near2 (foil or plate or sheet)))	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/24 23:15
S27	12	(pcb or ((circuit or wiring) adj board)) and ((press\$3 near6 heat\$3) with (nickel near2 (foil or plate or sheet)))	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/24 23:32
S29	32	(29/847,830,831,846).cds. and (pcb or ((circuit or wiring) adj board)) and (press\$3 with resin) and (polish\$3 with resin)	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/26 22:20
S32	13	[(29/847,830,831,846).cds. and (pcb or ((circuit or wiring) adj board)) and (press\$3 with resin with (circuit\$4 or wiring or conductor or trace or line)) and (polish\$3 with resin) and cur\$3	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/26 22:24
S34	13	[(29/847,830,831,846).cds. and (pcb or ((circuit or wiring) adj board)) and (press\$3 with resin with (circuit\$4 or wiring or conductor or trace or line)) and (polish\$3 with resin) and cur\$3	US-PCPUB; USPAT; IBM_TDB	OR	OFF	2008/02/26 22:26

S35	1	(156/295,285).cds. and (pcb or ((circuit or wiring) adj board)) and (press\$3 with resin with (circuit\$4 or wiring or conductor or trace or line)) and (polish\$3 with resin) and cur\$3	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/26 22:30
S36	10	(174/255,258).cds. and (pcb or ((circuit or wiring) adj board)) and (press\$3 with resin with (circuit\$4 or wiring or conductor or trace or line)) and (polish\$3 with resin) and cur\$3	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/26 22:30
\$37	2	[257/678,688).cds. and (pcb or ((circuit or wiring) adj board)) and (press\$3 with resin with (circuit\$4 or wiring or conductor or trace or line)) and (polish\$3 with resin) and cur\$3	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2008/02/26 22:32
S38	0	(PCB or (circuit adj method)) and ((circuit or signal or track or conductor) near4 (substractive adj method))	US-PGPUB; USPAT; USOCR; IBM_TDB	OR	ON	2009/02/02 10:07
S39	8	(PCB or (circuit adj board)) and ((circuit or signal or track or conductor) near4 (substractive adj method))	US-PGPUB; USPAT; USOCR; IBM_TDB	OR	ON	2009/02/02 10:07
S40	4	(murakami-keiichi).in. and (printed adj wiring adj board)	US-PGPUB; USPAT; USOCR; IBM_TDB	OR	ON	2009/02/02 10:39
S41	15	[29/847,830,831,846).cds. and (pcb or ((circuit or wiring) adj board)) and (press\$3 with resin with (circuit\$4 or wiring or conductor or trace or line)) and (polish\$3 with resin) and cur\$3	US-PGPUB; USPAT; USOOR; IBM_TDB	OR	OFF	2009/02/02 10:40
S42	1	(156/295,285).ccls. and (pcb or ((circuit or wiring) adj board)) and (press\$3 with resin with (circuit\$4 or wiring or conductor or trace or line)) and (polish\$3 with resin) and cur\$3	US-PGPUB; USPAT; USOOR; IBM_TDB	OR	OFF	2009/02/02 10:41
S43	13	(174/255,258).cds. and (pcb or ((circuit or wiring) adj board)) and (press\$3 with resin with (circuit\$4 or wiring or conductor or trace or line)) and (polish\$3 with resin) and cur\$3	US-PCPUB; USPAT; USOCR; IBM_TDB	OR	OFF	2009/02/02 10:41

S44	2	(257/678,688).ccls. and (pcb or	US-PGPUB;	OR	OFF	2009/02/02
	1	((circuit or wiring) adj board))	USPAT;			10:42
		and (press\$3 with resin with	USOOR;			
		(circuit\$4 or wiring or	IBM_TDB			
		conductor or trace or line)) and				
		(polish\$3 with resin) and cur\$3				

2/2/2009 10:44:02 AM

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